

PATENT APPLN. NO. 10/609,022
RESPONSE UNDER 37 C.F.R. §1.111

**PATENT
NON-FINAL**

IN THE CLAIMS:

1. (currently amended) A method of adhering a coating of a polymer, metal, metalloid oxide or fluorinated derivatives thereof to an electrical or opto-electronic surface of a device produced in a CMOS process comprising applying to said surface, as an adhesion promoter, a hybrid organic-inorganic material.

2. (original) The method of claim 1, wherein said inorganic portion of said hybrid material comprises silicon.